FPGA CONFIGURATION MEMORY WITH BUILT-IN ERROR
CORRECTION MECHANISM

FIELD OF THE INVENTION

[0001]   The present invention generally relates to error correction in programmable logic devices.

BACKGROUND OF THE INVENTION

[0002]   Digital logic can be implemented using several options: discrete logic devices, often called small-scale integrated circuits or SSI, programmable devices such as programmable logic arrays (PLAs) or programmable logic devices (PLDs), masked-programmed gate arrays or cell-based application specific integrated circuits (ASICs), and field programmable gate arrays (FPGAs).

[0003]   FPGAs are general purpose programmable devices that are customized by the end users. FPGAs are composed of an array of configurable logic blocks that are programmably interconnected. The basic device architecture of an FPGA consists of an array of configurable logic blocks (CLBs) embedded in a configurable interconnect structure and surrounded by configurable I/O blocks (IOBs). An IOB allows signals to be driven off-chip or optionally brought onto the FPGA onto interconnect segments. The IOB can typically perform other functions, such as tri-stating outputs and registering incoming or out-going signals. The configurable interconnect structure allows users to implement multi-level logic designs (multi-level refers to logic in which the output signal of one logic unit provides input to another logic unit and the output of that provides input to another, etc.). An FPGA can support hundreds of thousands of gates of logic operating at system speeds of tens of megahertz. The FPGA is programmed by loading programming data into the memory cells controlling the configurable logic blocks, I/O blocks, and interconnect structure.

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[0004]   Each configurable logic block in the FPGA can
include configuration memory cells for controlling the
function performed by that logic block. These configuration
memory cells can implement a lookup table, control
multiplexers, and control other logic elements such as XOR
gates and AND gates. A lookup table (LUT) stores a truth
table which implements that combinational logic function
corresponding to the truth table. Each configurable logic
block is associated with an adjacent portion of the
interconnect structure. The interconnect structure includes
programmable interconnect points which control the connection
of wiring segments in the programmable interconnect network
of the FPGA. Each programmable interconnect point may be a
pass transistor controlled by a configuration memory cell.
Wire segments on each side of the pass transistor are either
connected or not connected depending on whether the
transistor is turned on by the corresponding configuration
memory cell.

[0005]   Configuration is the process of loading a stream of
bits containing the program data into the configuration
memory cells which control the configurable logic blocks and
I/O blocks of the FPGA. The bitstream is loaded into the FPGA
serially to minimize the number of pins required for
configuration and to reduce the complexity of the interface
to external memory. The bitstream is broken into packets of
data called frames. As each frame is received, it is shifted
through a frame register until the frame register is filled.
The data in the frame register of the FPGA are then loaded in
parallel into one column of configuration memory cells
forming the memory array. (The configuration memory cells
which control a configurable logic block typically occupy a
two dimensional section of the array.) The configuration
memory cells make up the lookup tables and control
programmable interconnect points, multiplexers, and other
programmable elements of a configurable logic block or I/O
block. Following the loading of the first frame, subsequent
frames of bitstream data are shifted into the FPGA, and

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another column of configuration memory cells in the array of CLBs is designated to be loaded with a frame of bitstream data.

[0006]   Because the functions performed by the logic or I/O blocks are determined by the values of the configuration memory cells, any error in the values could affect the functions. In a FPGA configured to implement a complex design, it is possible that a single error could render the design inoperative. Although the memory cells are normally very reliable, there is a concern that they might be disturbed in a high-radiation or high-temperature environment. Consequently, it is desirable to include in the FPGA an error correction and reporting mechanism.

SUMMARY OF THE INVENTION

[0007]   The various embodiments of the invention provide a system and method for error correction in a programmable logic device (PLD). In one embodiment, a frame circuit retrieves data from each column of configuration memory of the PLD, and a check memory stores a plurality of check words. A buffer circuit is coupled to the check memory and to the frame circuit. The buffer circuit assembles blocks of data from data retrieved by the frame circuit and from corresponding check words in the check memory. A plurality of storage elements are provided for storage of status information. A check circuit is coupled to the storage elements and to the buffer circuit. Each block is checked by the check circuit using an error correcting code, and data indicating detected errors is stored in the storage elements.

[0008]   The above summary of the present invention is not intended to describe each disclosed embodiment of the present invention. The figures and detailed description that follow provide additional example embodiments and aspects of the present invention.

BRIEF DESCRIPTION OF THE DRAWINGS

[0009]   The present invention is illustrated by way of example, and not by way of limitation, in the detailed description and the following figures, in which like reference numerals refer to similar elements.

[0010]   FIG. 1 is a block diagram of an example FPGA.

[0011]   FIG. 2 is a schematic diagram of an error correction system for a configuration memory in accordance with various embodiments of the present invention.

[0012]   FIG. 3 is a schematic diagram of an example memory cell of configuration memory.

[0013]   FIG. 4 shows an alternative embodiment of configuration memory.

[0014]   FIG. 5 is a block diagram showing the input and output signals of an address module.

[0015]   FIG. 6 is a schematic diagram showing an example configuration module.

[0016]   FIG. 7 is a schematic diagram showing a stage of a shift frame register of the configuration module.

[0017]   FIG. 8 shows an error correcting code circuit in accordance with various embodiments of the invention.

[0018]   FIG. 9 is a flow chart of an example process for correcting configuration errors in accordance with various embodiments of the present invention.

[0019]   FIGs. 10, 11, and 12 show different systems capable of handling components that may by-design change state after configuration and under normal operation.

[0020]   FIG. 13 is a schematic diagram of a parity based error detection system of the present invention.

DETAILED DESCRIPTION OF THE INVENTION

[0021]   The present invention relates to FPGA error detection and correction systems and methods. In the following description, numerous specific details are set forth in order to provide a more thorough understanding of the present invention. However, it will be apparent to one

skilled in the art that the present invention may be practiced without these specific details. In other instances, well-known features have not been described in detail in order to avoid obscuring the present invention.

[0022]   FIG. 1 shows a schematic diagram of an embodiment of an FPGA 2 on which various embodiments of the invention may be used. FPGA 2 comprises a plurality of CLBs 4. Each CLB 4 in turn comprises a logic/IO block 6, a routing matrix 10 and associated memory cell group 8. Even though FIG. 1 shows block 6, matrix 10 and memory cell group 8 as individual blocks with sharp boundary, they may be physically distributed throughout the CLB. Logic/IO block 6 is a logic and/or input-output block that can be configured to perform one of a variety of logical and/or input-output functions. For example, logic/IO block 6 may be configured to be a wide AND gate decoder, a multi-bit adder, a multi-input combinational function generator, etc. Logic/IO block 6 is configured by storing data in the associated memory cell group 8 for logic/IO block 6. Transistor gates in logic/IO block 6 are coupled to associated memory cell group 8 for being controlled by configuration data that specifies the function logic/IO block 6 is to perform. Routing matrix 10 is used to couple the inputs and outputs of logic/IO block 6 with the inputs and outputs of other logic/IO blocks 6 via a plurality of programmable interconnections 7 for creating complex circuits on FPGA 2. Routing matrix 10 is also coupled to associated memory cell group 8 and is controlled by configuration data that are applied to the control inputs of routing matrix 10 so that the inputs and outputs of logic/IO block 6 are coupled as desired.

[0023]   Associated memory cell group 8 shown in FIG. 1 is preferably a group or section of configuration memory cells 14 from an array 12 of memory cells 14 (See FIG. 2). Memory cells 14 are preferably arranged in array 12 in rows and columns. In one embodiment of FPGA 2, logic/IO block 6, routing matrix 10, and associated memory cell group 8 of each CLB 4 are grouped together physically near each other across

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FPGA 2. This is advantageous because it reduces the amount of wiring needed. These components 6, 8, 10 may, however, be separated from each other or arranged in other configurations without departing from the spirit of the present invention. In any case, the electrical correspondence among components 6, 8, 10 is maintained. Thus, for each CLB 4 of an FPGA 2 there is a specific logic/IO block 6, a specific memory cell group 8, and a specific routing matrix 10. The memory cells 8, however, may be physically grouped together in one large array of memory cells whether or not the other components of each CLB 4 are separated. This large array of memory cells may be either separated from the logic/IO blocks 6 or may be integrated with the logic/IO blocks 6 and routing matrices 10.

[0024]   Referring now to FIG. 2, a schematic diagram of one embodiment of an error correction system for the configuration memory . This system comprises an array 12 of memory cells 14, an address module 16, a configuration module 18, an error correcting code circuit (ECCC) 13, and an error check memory 19. Circuit 13 and memory 19 are used for detecting and correcting errors in memory cells 14 in array 12. ECCC 13 records status information pertaining to error detection and correction in status register (SR) 21.

[0025]   Memory cells 14 are arranged in rows and columns. Each memory cell 14 has two inputs. One input, labeled D in FIG. 2, is a data input and is coupled to a frame register 11 of configuration module 18. The other input, labeled A in FIG. 2, is an address input and is coupled to address module 16. A signal applied on address input A controls when data on data input D is written into memory cell 14. In an alternative embodiment, data input D is bidirectional and data may be transferred in either direction between data input D and memory cell 14. In addition, each memory cell 14 has outputs not shown in FIG. 2 that are coupled to the appropriate logic/IO block 6 or routing matrix 10.

[0026]   FIG. 3 shows a memory cell 14 with an address input A, a differential data input D, and a differential output Q.

Differential output Q is coupled to the gates of transistors in logic/IO block 6 or routing matrix 10. This and other memory cell structures are further discussed in U.S. Pat. No. 5,764,564 which is incorporated herein by reference. Memory cells 14 are preferably static random access memory cells; however, those skilled in the art will realize that memory cells 14 may be implemented with other equivalent circuits such as an array of D-flip-flops or EEPROM cells.

[0027] The various embodiments of the present invention also provide a plurality of row buses 15 and column buses 17 for coupling the data inputs and the address inputs, respectively. In the embodiment of FIG. 2, each row bus 15 is coupled to the data input of each memory cell 14 in a row. Thus, there is one row bus 15 for each row of memory cells 14 in array 12. The data inputs for each row of memory cell 14 correspond to the data in frame register 11. Similarly, each column bus 17 is coupled to the address input of each memory cell 14 in a column. There is one column bus 17 for each column of memory cells 14 in array 12. Thus, each time the address signal is asserted on a column bus 17, all the memory cells 14 in that column are written with data stored in frame register 11. Therefore, an entire column of data can be written to array 12 simultaneously when an address is asserted. More details about address module 16 and configuration module 18 will be provided below.

[0028] In one embodiment, the error check words can be introduced into each frame (instead of centrally stored in one location). FIG. 4 shows such an embodiment of an array 12a. A plurality of bits for check words, such as bits 141-146, are added to the regular array. Typically, each frame includes a plurality of such check bits to create a check word for error correction. This plurality of distributed check bits functions in the same way as check memory 19. In this embodiment, all the bits in a frame, including the bits of the error check word, can be written at the same time.

[0029] The structure and operation of address module 16 are now described in detail. Address module 16 specifies the

column of array 12 that is to be written with data supplied
from configuration module 18, or read with data sent to
configuration module 18. As shown in FIG. 5, address module
16 preferably accepts a mode selection input, an address
increment input, and an address strobe input. The mode
selection input directs address module 16 to operate in one
of two modes: a configuration mode (active during
configuration) and an error correction mode (active after
configuration for error detection and correction). Address
module 16 generates an address empty output and a column bus.
Address module 16 preferably has a number of stages equal in
number to the number of columns in array 12. Each stage
stores an enable bit that specifies whether a particular
column is to be addressed. Since typically only one column
is addressed at a time, only one stage contains an active
enable bit. Each of the plurality of lines in the column bus
is coupled to the address input of memory cells 14 in a
respective column of array 12. For example, a first column
bus output of address module 16 is coupled to the address
inputs of memory cells 14 in the first column of array 12. A
second column bus output of address module 16 is coupled to
the address inputs of memory cells 14 in the second column of
array 12. Each subsequent column of memory cells 14 of array
12 is similarly coupled to a respective column bus output of
address module 16. The address increment input provides a
way of shifting the address enable bits through the stages of
address module 16.

[0030]   In the configuration mode, each column of array 12
is active once. Thus, each memory cell 14 is configured
once. After all the columns have been addressed, address
module 16 generates the address empty output to indicate the
end of configuration. In the error correction mode, for one
embodiment one column after another is active in a continuous
sequential manner because the memory cells need to be
verified repeatedly. Thus, no address empty output is
generated.

[0031]   Address module 16 accepts the address strobe input
generated by control unit 24a for controlling whether the
address lines in the column bus are asserted. This is
advantageous because the memory cells 14 of array 12 will be
accessed only when the address strobe signal is applied.

[0032]   The structure and operation of configuration module
18 are now described in detail. Referring now to FIG. 6, a
schematic diagram is shown for a configuration module 18a
that can be used in the present invention. Configuration
module 18a comprises a data input register 20a, a read-back
select unit 101, a shift frame register 11, a readback data
flip flop 112, and a control unit 24a.

[0033]   Data input register 20a is a parallel in, serial
out shift register having eight stages 20-1 through 20-8.
Data input register 20a has eight data input terminals 110,
two clock input terminals 31, a load input terminal 30, and a
serial output terminal 103. The data to be stored in memory
cells 14 are applied to the eight data input terminals 110
for loading. The data are loaded in parallel, eight bits at
a time, through the input terminals of data input register
20a. The data are then serially transferred out of data
input register 20a onto terminal 103. The output of a first
stage 20-1 is the serial output of data input register 20a.
It should be noted that register 20a may have more (or less)
than eight stages.

[0034]   Data are transferred out of data input register 20a
through OR gate 102 into flip flop 104 and from there into
shift frame register 11. Shift frame register 11 is a
serial-in, parallel-out shift register and comprises a
plurality of stages 11-1 through 11-n. Shift frame register
11 receives a two-phase clock signal on a bus 32, a clear
input signal on line 34, a data input signal on line 106, and
provides a serial data output signal (Serial Out) on line 108
and a plurality of parallel bidirectional data signals on
lines P1 through Pn. There is a stage in shift frame
register 11 for each row of memory cells 14 in array 12.

Stages 11-1 through 11-n shift data one stage down for each cycle of the clock signal on bus 32. The data input terminal of shift frame register 11 is coupled to line 106. As shown in FIG. 2, each of the plurality of parallel data bidirectional lines P1 through Pn is coupled to a row of memory cells 14 in array 12. The serial data output of shift frame register 11 on line 108 is coupled to control unit 24a.

[0035]   Control unit 24a comprises a state machine which generates a plurality of signals to control the operation of configuration module 18a. The signals generated by control unit 24a include: a two-phase clock signal Clk on bus 31 coupled to the clock input terminals of each stage in data input register 20a, to readback select unit 101 and to readback data flip flop 112; a load signal (Load) on line 30 coupled to the load input terminal of data input register 20a; a second two-phase clock signal (Clock) on bus 32 coupled to the clock input terminals of shift frame register 11; and a clear signal (Clear) on line 34 coupled to the clear input terminals of stages of shift frame register 11 for clearing shift frame register 11. In one embodiment of configuration module 18a, the first clock signal (Clk) may be identical to the second clock signal (Clock).

[0036]   Those skilled in the art will recognize how to construct control unit 24a from the functional description that follows.

[0037]   To place shift frame register into configuration mode, control unit 24a applies a high signal on write line 27. This allows shift frame register 11 to shift data. The write signal remains high and the read signal remains low during the entire configuration sequence. Control unit 24a also sets a mode selection signal 39 into one value (e.g., a "high" value). This signal is coupled to the mode selection input of address module 16 to indicate that configuration mode is in progress.

[0038]   Before data are loaded into shift frame register 11, shift frame register 11 is cleared to logic "0" by

asserting a Clear signal on line 34. The first bit loaded
into the first stage 20-1 of data input register 20a is
preferably a control bit ("1") and the remaining bits loaded
into stages 20-2 through 20-8 are the first seven bits data
to be loaded into memory cells 14. Shift frame register 11
is then clocked to load the control bit from first stage 20-1
of data input register 20a through readback select unit 101
to first stage 11-1 of shift frame register 11. The
remaining bits loaded into data input register 20a are
serially shifted into shift frame register 11 by clocking
data input register 20a, readback select unit 101, and frame
shift register 11 seven more times. This process of loading
and serially shifting is repeated once for each eight rows of
memory cells 14 in array 12. For example, this process would
be repeated at least three times if there were twenty-four
rows in array 12.

[0039]   When control unit 24a shifts the control bit out of
the last stage 11-n of shift frame register 11, control unit
24a recognizes that shift frame register 11 is fully loaded
and that the data may be transferred to the column of memory
cells 14 of array 12. Control unit 24a then applies an
address strobe signal on line 36, to store the data held in
shift frame register 11 into a column of memory cells 14 in
array 12. This strobe signal is applied to the address
strobe input of address module 16. Control unit 24a
continues to assert the strobe signal until control unit 24a
detects a control bit on bit stream monitor line 35 which
connects to the output terminal of data input register 20a.
Control unit 24a then applies the address clock signal on
line 37. This signal is connected to the address increment
input of address module 16, and it causes address module 16
to advance to the next column. When all the columns in array
12 have been loaded, address module 16 returns a high AREmp
signal on its address empty output. This signal is coupled
to line 38 to indicate that address module 16 is empty and
the entire array 12 has been loaded.

[0040]   Configuration module 18a also allows for reading
back data from the array 12. The data read back are used for
error correction. In this mode of operation, the mode
selection signal on line 39 is set at a value (e.g., logic
"low") that is opposite to the configuration mode. A bit,
such as bit 11-i, of shift frame register 11 is shown in
detail in FIG. 7 to further describe this aspect of the
invention. Before reading back data, shift frame register 11
is cleared with a high signal on line 34. At the same time,
a high token signal RBToken is loaded on line 29 through OR
gate 102 into flip flop 104. The read signal on line 26 is
brought low and the write signal on line 27 is brought high,
which, as can be seen in FIG. 7, precharges line Pi
(represents lines P1 through Pn) to logic high. The read
signal on line 26 is then brought high and the write signal
on line 27 is brought low, which turns off the power to
transistors 75 through 78, turns off transistor 74, and turns
on transistor 71. A high address strobe signal on line 36
applies data from the addressed column on array 12 to lines
P1 through Pn. When clock signal Clk1 (on line 32-1 of 2-bit
bus 32) goes high, line Pi drives the input terminal 86 of
master latch 79 and the data value is stored in master latch
79. The address strobe signal on line 36 is then brought low
and Clk1 is brought low. When Clk2 goes high, the data bit
shifts to slave latch 80.

[0041]   During this time, the low write signal on line 27
has held transistor 74 off so that data do not shift along
the shift register. The shift register is now loaded with
one bit for each row in the addressed column, and the next
operation will be to shift this column of data out of the
shift register. Next, the read signal on line 26 is brought
low and the write signal on line 27 is brought high so that
data shift from one stage to the next in shift frame register
11. Clk1 and Clk2 alternately are brought high (with non-
overlapping clock signals) so that data shift downward and
out onto line RBData 108. Shifting continues until the
column of data is shifted entirely out. Completion of

shifting is detected when the DREmpty signal appears at the
output of register 42. Another column is addressed, loaded,
and shifted and the process is repeated until all columns
have been shifted out.

[0042]   In one embodiment of the present invention, the
data on line RBData 108 is coupled to ECCC 13, which,
together with the stored check words, determines whether
there is any error in memory cells 14. If correctable errors
are discovered, ECCC 13 corrects the error, and delivers the
corrected data to data input register 20a of configuration
module 18a. ECCC 13 also generates an error correction
signal 40 (ECS) and applies it to control unit 24a of
configuration module 18a. Control unit 24a will then
transfer the data to shift frame register 11 for loading back
to the corresponding memory cells 14.

[0043]   The structure and operation of error correcting
code circuit (ECCC) 13 are now described in detail.
Referring now to FIG. 8, a block diagram is shown for the
ECCC 13 that can be with various embodiments of the present
invention. ECCC 13 comprises a buffer 170, an ECC checker
171, correction logic 172, and a status register 21.

[0044]   The frame data to be checked and possibly corrected
by the error correcting code is received from configuration
memory by the buffer 170. Buffer 170 is used to convert the
size of configuration data from frames to the data size
needed by the error correcting code. The buffer 170 is also
used to assemble the blocks that are checked by the checker
171 from the converted data and the check word for the block.

[0045]   Because the chosen error correcting code may differ
in length from that of a frame, "blocks" of configuration
data are assembled to be checked for errors. The frame size
is dependent upon the physical size of the FPGA whereas the
data size needed by the error correcting code (ECC) is
dependent upon the length of the chosen ECC. In one
embodiment the frame size may be equal to the size of the
ECC, and the buffer 170 need not convert data sizes. In

another embodiment, the size of a frame may be made to match
the ECC by padding the frame with constant data.   In yet
another embodiment the optionally padded frame may be
partitioned by the buffer 170 into a number of sections with
each section matching the size of the ECC.   In another
embodiment, the frame data arrives serially one bit at a
time, and checker 171 consumes one bit at a time.

[0046]   After converting the configuration data to the
appropriate size, buffer 170 creates blocks by appending the
check word for the block to the converted data.   In one
embodiment, as the blocks are assembled the corresponding
check words are fetched from sequential locations in check
memory 19 (FIG. 2) by the buffer 170.   In another embodiment
check memory 19 is located within dedicated configuration
memory and so the check words arrive included in the frame
data.

[0047]   ECC checker 171 uses a block ECC to check for
errors.   Each block checked by the checker 171 is composed of
an information word and a check word.   The information word
(the block data) contains the frame data that is protected by
the ECC.   The check word, previously generated from the block
data, and the current block data are checked for any errors
of changed block bits.   Errors may be in the block data or
the check word, or both.

[0048]   In one embodiment the detection of any errors by
checker 171 is performed by recalculating the check word for
the ECC and detecting an error when the recalculated check
word is different from the check word from check memory 19.
This embodiment has the advantage that a check word generator
used to initialize check memory 19 during FPGA configuration
may also be used by the checker 171.   In this embodiment
separate logic may be used for the correction logic 172.
Because errors may be expected to be infrequent, the
correction logic 172 may be implemented with slower logic,
thereby permitting a reduction in size of the correction
logic 172.   In another embodiment the checker 171 uses a
parity check matrix for the ECC to produce a syndrome.   An

error is detected by the checker 171 when the syndrome is non-zero.

[0049]   The correction logic 172 classifies the type of error detected by the checker 171. For certain ECC, some detected errors can be corrected while other detected errors cannot be corrected. So the correction logic 172 classifies each detected error as either a correctable error or an uncorrectable error. For example a Bose-Chaudhury-Hocquenghem (BCH) code can correct 1 and 2 bit errors and detect but not correct 3 bit errors. The error classification is sent to the status register 21 for logging. For correctable errors, the correction logic 172 corrects the errors and supplies the corrected block data and corrected check word to the buffer 170. The buffer 170 then returns the corrected block data to configuration memory and the corrected check word to check memory.

[0050]   The status register 21 is used for reporting the detected errors. In one embodiment the status register is a 32 bit register with 8 bit fields for corrected errors 174, uncorrected errors 175, and user errors 176. Each of fields 174-176 is an 8 bit saturating counter for counting the respective errors. The counters saturate to prevent overflow by stopping at the maximum count of 255 errors. The user errors field 176 may be used by configured user logic to track user error information. Each of fields 174-176 is cleared upon setting the reset bit 177. By periodically reading and clearing the error counters 174-176, the error rate can be determined for each type of error. In an alternative embodiment the fields 174-176 are 1 bit fields that flag the occurrence of the respective error.

[0051]   FIG. 9 is a flow chart of an example process 130 for correcting configuration errors in accordance with various embodiments of the present invention. In step 132 the buffer 170 is cleared and the address module 16 is set to start at the first column. At step 134 a check is made to determine whether more frame data must be retrieved because the buffer 170 of ECCC 13 does not yet contain an entire data

block. When there is insufficient data in the buffer 170,
the process proceeds to step 136 to have the configuration
module 18 retrieve a column of data from memory cells 14. In
one embodiment , this data is loaded into frame register 11,
although another register (inside or outside of ECCC 13) may
be used.

[0052]   The retrieved data in frame register 11 is sent to
buffer 170 of ECCC 13. After a frame is retrieved, at step
138 the address module 16 is advanced to the next column.
ECCC 13 can access data in check memory 19, which contains
the check word associated with each block. In step 140 once
a block is available the block is checked for any errors with
an ECC by checker 171 of ECCC 13. At step 142, in the case
when no error is detected, the process advances to step 144
to remove the block from buffer 170, and then the process
checks whether all of configuration memory has been checked
at step 146. While there is more configuration memory to
check, the process iterates at step 134, otherwise checking
is complete at step 148.

[0053]   When there is an error at step 142, the process
advances to step 150 to check on the error classification
determined by correction logic 172. For some ECC, all
detectable errors are correctable error so in these cases the
process always advances to step 152. At step 152 the
correctable error is logged in field 174 of status register
21.

[0054]   At step 154 the correction logic 172 corrects the
error, and at step 156 the corrected block is sent to the
buffer 170 and the corrected block data is returned to
configuration memory by the configuration module 18. The
corrected check word is also returned to check memory 19 at
step 162. At step 150, when the detected error is an
uncorrectable error, the process advances to step 158 where
the uncorrectable error is logged in field 175 of status
register 21. Typically an uncorrectable error is treated by
configured user logic as a fatal error that causes the FPGA
system to be reset. However, in some cases the FPGA system

must continue even with the uncorrectable error. One example
is when an error rate for uncorrectable errors needs to be
measured. In one embodiment to allow the next error to be
detected at step 160 the current uncorrectable error is
masked by recalculating the check word over the corrupted
data. At step 162 this recalculated check word is written
into check memory 19.

[0055]   The checking of configuration memory can be done
continuously, periodically, or in response to a detected
error as is later discussed in detail.

[0056]   In an embodiment of the present invention, the ECC
can be used to correct a single bit of error in a data block
of memory cells 14. In other embodiments of the invention,
several bits of errors can be corrected, or several bits of
errors can be corrected and additional bits of errors can be
detected. It should be noted that the size of storage 19
needs to be increased or a longer block ECC must be used if
there is a need to correct multiple bits in a column. Many
error correcting codes and circuits have been disclosed in
various publications (e.g., J.Wakerly, "Error Detecting
Codes, Self-Checking Circuits and Applications," Elsevier
North-Holland, New York, 1978), and they can be used in the
present invention. The codes include BCH, Reed-Solomon, and
turbo codes.

[0057]   In one embodiment of the present invention, the
error check words may be generated on-chip. In this
embodiment, configuration module 18 copies the data in frame
register 11 to checker 171 of ECCC 13 when the data is first
loaded into frame register 11 during configuration. ECCC 13
computes the error check words, and stores the check words
into corresponding locations in check memory 19. In another
embodiment , the error check words are generated off-chip.
These check words are integrated into the configuration
bitstream, and delivered to the FPGA during power up. In
this case ECCC 13 merely retrieves the error check words from
the bitstream, and stores the bits into appropriate locations
in check memory 19.

[0058]   It will be recognized that the states of some of
the components in a CLB may change after configuration during
normal operation. Examples of such components are flip-flops
and random access memory. FIG. 10 shows a system 180 that
addresses this issue. Elements in FIGS. 2 and 10 that are
similar have the same reference numerals. System 180 contains
a frame register 11a that reads back the states of CLBs (such
as 182a and 182b). The data in frame register 11a is
delivered to an error correcting code circuit 13a. Circuit
13a reads data stored in a mask storage 184, which stores
information that indicates which bits in the CLBs may
intentionally change during operation. The error correction
algorithm is performed on the frame data with these variable
bits masked by substituting 0 or other constant data for
these bits. Since the CLB configuration typically spans
several frames, the location of the masked bits will be
different from frame to frame, but repeating regularly.
Similarly, since each frame contains data from several CLBs,
the mask data may represent a single CLB and the ECC circuit
13a repeats the mask for each CLB in the frame. As a result,
the computation of the error check will not be affected by
the changed states.

[0059]   Data in mask storage 184 can be set up using
several methods. The data can be stored in mask-programmed
read-only memory on chip because the locations of the
potentially-changeable parts are known in advance. The data
can also be included in the bitstream, and loaded into
writable memory on chip. In the situation where it is not
desirable to include the complete mask data in the bitstream,
the bitstream could include an indicator on a CLB-by-CLB
basis on whether or not to use the mask. For example, the
bitstream could turn on the mask for those LUTs that are used
as memory, while leaving the others unchanged (and therefore
correctable).

[0060]   Another way to solve this problem is shown in a
system 190 of FIG. 11. The error correcting code circuit
contains a logic device 191 (such as an AND gate) having an

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input terminal 194 connected to one of the above-mentioned
components of a CLB (such as a flip-flop 196), the state of
which may change after configuration. Another input terminal
192 of logic device 191 is connected to a signal that
indicates whether the state of flip-flop 192 has been
intentionally changed after configuration. If the state has
been intentionally changed, logic device 191 will shield the
change from the error correcting code circuit. Alternatively,
terminal 192 can be a signal that indicates the bit is
permitted to change during operation. This signal may be
determined from other configuration bit settings such as
enabling LUT Ram mode.

[0061]   In yet another embodiment (FIG. 12), the CLB
contains additional bits 114 that read back the values that
indicate which bits may change during configuration. ECCC 13b
contains the logic device that clears the appropriate
variable bits in the bitstream before computing the error
check.

[0062]   It is important to note that in addition to
preventing variable bits from being read back, the FPGA must
also prevent these bits from being written when an error is
being corrected. The same signals are used to either prevent
new values from being driven on data bus 15 or by preventing
the variable memory cells from being addressed and hence
overwritten.

[0063]   A different embodiment that provides error
detection and correction is now described. This embodiment
uses at least one parity bit to represent the correct state
of memory cells. A change in any parity bit triggers error
correction actions. FIG. 13 is a schematic diagram of a
parity based error correction system 200 of the present
invention. System 200 comprises a plurality of parity bit
generators, such as generator 204-207, that generate parity
bits of selected combinations of memory cells (e.g., one or
more frames or subsets of a frame), such as combinations 210-
213. The parity bits computed from the original
configuration bits of the corresponding combinations are

stored in registers of an on-chip storage 220. For example,
the parity bits of combinations 210-213 are stored in
registers 222-225, respectively. The output of a parity bit
generator and the corresponding parity bit stored in storage
220 are coupled to separate inputs of a XOR gate (or, in some
situations, a XNOR gate). When there is a change in one of
the memory cells connected to parity bit generator 204, the
output of generator 204 changes state. This will immediately
trigger action to correct the error. As a result, there is
almost no delay. One advantage of this embodiment is that
there is no need to use address module 16 and configuration
module 18 to periodically or continuously check memory cells
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[0064]   In one embodiment of the present invention, the
trigger will cause the configuration bits of the
corresponding frame(s) or subset of a frame to be reloaded
from external memory. The correct data is loaded into the
corresponding memory cells. In another embodiment of the
present invention, ECCC 13 and error check memory 19 can be
used in combination with error correction system 200. The
error check words stored in check memory 19 are retrieved to
reconstruct the original bits. As a result, there is no need
to rely on an external memory.

[0065]   Parity bits are used to detect an odd number of bit
changes in a combination of memory cells. It should be noted
that other error detection codes (and the corresponding error
detection circuits) may also be used to detect other types of
bit changes.

[0066]   Note that not all bits need to be included in a
parity chain. For example, the bits that are permitted to
change during normal operation of the FPGA can be omitted.

[0067]   It can be seen from the above description that a
novel error correction system and methods for implementing
the same have been disclosed. Those having skill in the
relevant arts of the invention will now perceive various
modifications and additions which may be made as a result of

the disclosure herein. Accordingly, all such modifications
and additions are deemed to be within the scope of the
invention, which is to be limited only by the appended claims
and their equivalents.